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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/832,093	04/11/2001	Shigeo Ishikawa	Q64059	8684	
7590 06/07/2005			EXAM	EXAMINER	
SUGHRUE, MION, ZINN, MACPEAK & SEAS 2100 Pennsylvania Avenue, N.W. Washington, DC 20037			NGUYEN, KHIEM D		
			ART UNIT	PAPER NUMBER	
3 , –			2823		
				DATE MAILED: 06/07/2005	

Please find below and/or attached an Office communication concerning this application or proceeding.

		H'!				
	Application No.	Applicant(s)				
Office Action Commons	09/832,093	ISHIKAWA, SHIGEO				
Office Action Summary	Examiner	Art Unit				
	Khiem D. Nguyen	2823				
The MAILING DATE of this communication appeared for Reply	ppears on the cover sheet with	the correspondence address				
A SHORTENED STATUTORY PERIOD FOR REP THE MAILING DATE OF THIS COMMUNICATION - Extensions of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a re - If NO period for reply is specified above, the maximum statutory perio - Failure to reply within the set or extended period for reply will, by statu. Any reply received by the Office later than three months after the mail earned patent term adjustment. See 37 CFR 1.704(b).	I. 1.136(a). In no event, however, may a reply eply within the statutory minimum of thirty (3) d will apply and will expire SIX (6) MONTHS ute. cause the application to become ABANI	be timely filed O) days will be considered timely. If from the mailing date of this communication. DONED (35 U.S.C. & 133).				
Status						
1)⊠ Responsive to communication(s) filed on 18	May 2005.					
<u> </u>	nis action is non-final.					
<u>, </u>	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims						
4) ⊠ Claim(s) 1-3,5 and 8-11 is/are pending in the 4a) Of the above claim(s) is/are withdr 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) 1-3,5 and 8-11 is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and	rawn from consideration.					
Application Papers						
9) The specification is objected to by the Examir 10) The drawing(s) filed on 11 April 2001 is/are: a Applicant may not request that any objection to th Replacement drawing sheet(s) including the corre	a) \square accepted or b) \square objected by accepted or b) \square objected by acceptance. Section is required if the drawing(s) is	See 37 CFR 1.85(a). s objected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Bure. * See the attached detailed Office action for a list	nts have been received. nts have been received in Appl iority documents have been rec au (PCT Rule 17.2(a)).	ication No beived in this National Stage				
Attachment(s)						
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date 	Paper No(s)/M	mary (PTO-413) ail Date nal Patent Application (PTO-152)				

DETAILED ACTION

Response to Amendment

Applicant's request for reconsideration of the finality of the rejection of the last Office action is persuasive and, therefore, the finality of that action is withdrawn.

The rejection of the previous Office Action are withdrawn in view of the applicant's arguments. A new rejection is made as set forth in this Office Action. Claims (1-3, 5, and 8-11) are pending in the application.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-3, 5 and 8-11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Li et al. (U.S. Pub. 2002/0160113).

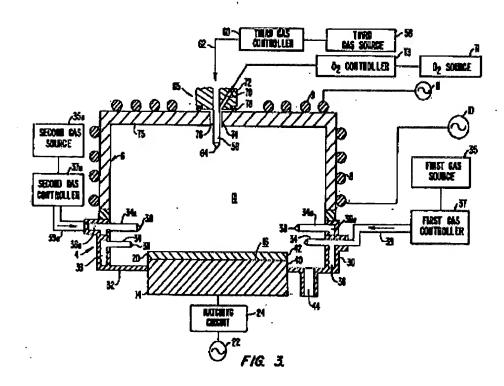
In re claim 1, <u>Li</u> discloses a method of forming an oxide film, comprising the steps of:

- (a) starting a supply of a reaction gas at a first flow rate into a chamber 18 in which a plasma is formed (page 3, paragraph [0024]), such that an initial film is formed on a center region of a wafer 20 via a first nozzle 56 provided on the chamber above the center region of the substrate (page 3, paragraph [0027]) and
- (b) starting a supply of the reaction gas at a second flow rate into the chamber in which the plasma is formed via second nozzle 34 and 34a wherein the second nozzle are

provided on side walls of the chamber above the wafer (page 3, paragraph [0025]), after the step (a), while the supply of the reaction gas at the first flow rate continues such that the oxide film is formed on the initial film (page 3, paragraph [0028], page 4, paragraphs [0035]-[0038] and **FIG. 3**), the first flow rate (36 sccm) being smaller than the second flow rate (44 sccm) (page 4, paragraph [0038]),

Nozzles (56 and 64) positioned over the center of the substrate 20 inherently producing the film on the center region, and

wherein the formation of the oxide film is initiated from the center region of the wafer in the above step (a), and the oxide film is formed on the whole of the wafer in step (b).



Li does not explicitly disclose that the step (b) is carried out 1 to 10 seconds after the step (a) is carried out as recited in the Applicant's claimed invention.

However, there is no evidence indicating the starting time range and the flow rate ranges is critical and it has been held that it is not inventive to discover the optimum or workable range of a result-effective variable within given prior art conditions by routine experimentation. See MPEP § 2144.05. Note that the specification contains no disclosure of either the critical nature of the claimed dimensions of any unexpected results arising there from. Where patentability is aid to be based upon particular chosen dimensions or upon another variable recited in a claim, the Applicant must show that the chosen dimensions are critical. In re Woodruff, 919 F.2d 1575, 1578, 16 USPQ2d 1934, 1936 (Fed. Cir. 1990).

In re claims 2 and 3, <u>Li</u> discloses the reaction gas is a compound gas containing Si and wherein the reaction gas is one of SiH₄ and SiF₄ (page 3, paragraph [0028]).

In re claim 5, <u>Li</u> does not explicitly disclose wherein the step (b) is carried out 1 to 10 seconds after the step (a) is carried out and wherein the first flow rate is in a range of one fifth to one tenth of the second flow rate. Also, note that there is no evidence indicating the starting time and the flow rate ranges is critical and it has been held that it is not inventive to discover the optimum or workable range of a result-effective variable within given prior art conditions by routine experimentation. See MPEP § 2144.05.

Note that the specification contains no disclosure of either the critical nature of the claimed dimensions of any unexpected results arising there from. Where patentability is aid to be based upon particular chosen dimensions or upon another variable recited in a

claim, the Applicant must show that the chosen dimensions are critical. <u>In re Woodruff</u>, 919 F.2d 1575, 1578, 16 USPQ2d 1934, 1936 (Fed. Cir. 1990).

In re claim 8, <u>Li</u> discloses a method of forming an oxide film, comprising the steps of:

- (a) forming an initial film from a center region of a wafer by supplying a reaction gas at a first flow rate, via a first nozzle 56 wherein the first nozzle is provided on the chamber 18 above a center of the wafer 20 (page 3, paragraph [0027]) in which a plasma is formed (page 3, paragraph [0024]), such that an initial film is formed on a center region of a wafer 20, while a thickness of the film is equal to or thinner than 10 nm and
- (b) forming the oxide film on the wafer, by starting to supply the reaction gas at a second flow rate, via second nozzle 34 and 34a wherein the second nozzle are provided on side walls of the chamber above the wafer (page 3, paragraph [0025]), after the step (a), while continuing to supply the reaction gas at the first flow rate (page 3, paragraph [0028], page 4, paragraphs [0035]-[0038] and FIG. 3),

Nozzles 56 and 64 positioned over the center of the substrate 20 inherently producing the film on the center region,

wherein the formation of the oxide film is initiated from the center region of the wafer in the above step (a), and the oxide film is formed on the whole of the wafer in step (b).

Li does not explicitly disclose that the step (b) is carried out 1 to 10 seconds after the step (a) is carried out as recited in the Applicant's claimed invention.

However, there is no evidence indicating the starting time range and the flow rate ranges is critical and it has been held that it is not inventive to discover the optimum or workable range of a result-effective variable within given prior art conditions by routine experimentation. See MPEP § 2144.05. Note that the specification contains no disclosure of either the critical nature of the claimed dimensions of any unexpected results arising there from. Where patentability is aid to be based upon particular chosen dimensions or upon another variable recited in a claim, the Applicant must show that the chosen dimensions are critical. In re Woodruff, 919 F.2d 1575, 1578, 16 USPQ2d 1934, 1936 (Fed. Cir. 1990).

In re claim 9, <u>Li</u> does not explicitly disclose wherein the first flow rate is in a range of one fifth to one tenth of the second flow rate and wherein the step (b) is carried out 1 to 10 seconds after the step (a) is carried out.

However, there is no evidence indicating the starting time and the flow rate ranges is critical and it has been held that it is not inventive to discover the optimum or workable range of a result-effective variable within given prior art conditions by routine experimentation. See MPEP § 2144.05. Note that the specification contains no disclosure of either the critical nature of the claimed dimensions of any unexpected results arising there from. Where patentability is aid to be based upon particular chosen dimensions or upon another variable recited in a claim, the Applicant must show that the chosen dimensions are critical. In re Woodruff, 919 F.2d 1575, 1578, 16 USPQ2d 1934, 1936 (Fed. Cir. 1990).

In re claims 10 and 11, <u>Li</u> discloses the reaction gas is a compound gas containing Si and wherein the reaction gas is one of SiH₄ and SiF₄ (page 3, paragraph [0028]).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Khiem D. Nguyen whose telephone number is (571) 272-1865. The examiner can normally be reached on Monday-Friday (8:30 AM - 5:30 PM).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri can be reached on (571) 272-1855. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

K.N. June 02nd, 2005



W. DAVID COLEMAN PRIMARY EXAMINER